January 21, 2005 Date



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application	ı No.:	10/706,203
Filed: N	ovember	12, 2003
Inventors:		
David K	. Kim	
William	W. Ruck	man
Wenjun	Chen	

EMI SEAL FOR SYSTEM Title:

CHASSIS

Ngo, Hung V. Examiner: Group/Art Unit: 2831 Atty. Dkt. No: 5681-73200 I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to M/S RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below. Robert C. Kowert Printed Name

INFORMATION DISCLOSURE STATEMENT

M/S RCE

P.O. Bo	ox 1450	22313-1450
Sir:		
	Applica	ant requests consideration of \(\sum \) the references listed on the attached Form PTO-
1449 aı	nd/or 🛚	the additional information identified below in paragraph 3.
	\boxtimes	A copy of each required reference listed on the Form PTO-1449 is enclosed.
		The references listed on the Form PTO-1449 were previously cited in application serial no to which the captioned application is seeking priority under 35 U.S.C. §120; therefore, a copy of each reference is not enclosed.
1.	This In	formation Disclosure Statement is submitted:
	a.	within 3 months of the filing date of a national application other than a continued prosecution application under § 1.53(d); within 3 months of the date of entry of the national stage as set forth in § 1.491 in an International application;

	b.		before the mailing date of a first Office Action on the ments; or before the mailing of a first Office Action after the filing of a request for continued examination under § 1.114. after the events of above paragraph 1a and prior to the mailing date of a final Office Action or Notice of Allowance, and thus: the certification of paragraph 2 below is provided, or a fee of \$180.00 (submitted with electronic IDS).
	c.		after the mailing date of a final Office Action or a Notice of Allowance and prior to payment of the issue fee, and thus: the certification of paragraph 2 below is provided and a fee of \$180.00 is enclosed.
2.	It is her	reby cer	tified:
		was ci	ch item of information contained in this Information Disclosure Statement ted in a communication from a foreign patent office in a counterpart a application not more than three (3) months prior to the filing of the tent; or
		was ci foreign after n	ted in a communication from a foreign patent office in a counterpart application or, to the knowledge of the person signing the certification taking reasonable inquiry, was known to any individual designated in § more than three (3) months prior to the filing of the Statement.
		was ci applica designa	ch item of information contained in this Information Disclosure Statement ted in a communication from a foreign patent office in a counterpart ation and that this communication was not received by any individual ated in § 1.56(c) more than thirty (30) days prior to the filing of the ation disclosure statement;
3.	\boxtimes		leration of the following additional information (including any co-pending addoned U.S. applications, prior uses and/or sales, etc.) is requested:
		U.S. Pa	atent Application Serial No. 10/807,743 (5681-74100)
4.	For eac	h non-E	English language reference listed on the attached Form PTO-1449:
		referen	ce is made to an English language translation submitted herewith, and/or
			ace is made to a foreign patent office search report (in the English ge) submitted herewith, and/or
			ace is made to an English language translation of a foreign patent office report submitted herewith, and/or
			ace is made to the concise explanation contained in the specification of the tapplication at page(s), and/or
	П	referen	ace is made to the concise explanation set forth below:

Application Serial No. 10/706,203 - Filed November 12, 2003

5.	Ш	Applicant also offers the following comments for the Examiner's consideration:
6.		Also enclosed is a copy of a foreign search report citing these references.
7.		The listed documents were brought to the attention of the Applicant(s) after payment of the issue fee in the captioned case. The documents were cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement. Applicant(s) request this Information Disclosure Statement and attached Form PTO-1449 be placed in the file of the captioned application.
8.		Applicant(s) requests that the Information Disclosure Statement and attached Form PTO-1449 and references, which are being filed before the grant of the patent and pursuant to 37 C.F.R. § 1.97(i), be placed in the file of the captioned application.
	If a	ny required fees are missing, the Commissioner is authorized to charge said fees to
Meyer	rtons,	Hood, Kivlin, Kowert & Goetzel, P.C. Deposit Account No. 501505/5681-

Respectfully submitted,

Robert C. Kowert Reg. No. 39,255

Attorney for Applicant(s)

MEYERTONS, HOOD, KIVLIN, KOWERT & GOETZEL, P.C. P. O. Box 398 Austin, Texas 78767 (512) 853-8800

Date: January 21, 2005

73200/RCK.



Form PTO-1449 (modified)

List of Patents and Publications For Applicant's Information

Disclosure Statement

(Use several sheets if necessary)

ATTY. DKT. NO. 5681-73200

SERIAL NO. 10/706,203

APPLICANT: Kim, et al.

GROUP: 2831

FILING DATE: November 12, 2003

<u>(</u> L	Jse severa	l sheets if necessary)	FILING DA	TE: November 12, 2003	<u> </u>		
		υ	J.S. PATENT	DOCUMENTS			
EXAM. INITIALS	REF. DES.	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE II APPROPRIATE
		6,723,915	4/20/04	Radu, et al.			
		5,586,011	12/17/96	Alexander			
		5,180,905	1/19/93	Chen, et al.			
		5,256,867	10/26/93	Cheng			
		6,239,359	5/29/01	Lilienthal, II, et al.			
		6,088,231	7/11/00	Fajardo			
		6,252,313	6/26/01	Zhang, et al.			
-		6,362,977	3/26/02	Tucker, et al.			
11 - 12/11		6,278,617	8/21/01	Yang, et al.			
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		6,198,630	3/6/01	Cromwell			
		5,357,404	10/18/94	Bright, et al.			
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		6,269,863	8/7/01	Wyler			
		6,140,577	10/31/00	Rapaich, et al.			
		6,137,051	10/24/00	Bundza			de la companya de la
		5,825,634	10/20/98	Moorehead, Jr.			
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		6,683,796	1/27/04	Radu, et al.			
		6,057,600	5/2/00	Kitazaw, et al.			
		6,400,164	6/4/02	Sampath			
7.00		6,063,999	5/16/00	Kelly		•	
	1	5 166 570	11/24/02	6.11			

EXAMINER:

5,166,772

DATE CONSIDERED:

Soldner, et al.

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the patent owner.

11/24/92

For Applicant's Information Disclosure Statement (Use several sheets if necessary) FILING DATE: November 12, 2003			ATTY. DKT. NO. 5681-73200		SER	SERIAL NO. 10/706,203 GROUP: 2831		
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DOCUMENT NUMBER DATE INAME CLASS APPROPRIATE			U	S. PATENT	DOCUMENTS			
5,639,889 6/17/97 Higgins, III 6,573,590 6/3/03 Radu, et al. 6,483,406 11/19/02 Sawa, et al. 6,703,704 3/9/04 Alcoe, et al. 6,597,575 7/22/03 Matayabes, et al. 6,320,257 11/20/01 Jayaraj, et al. 6,297,551 10/2/01 Dudderar, et al. 6,297,551 10/2/01 Dudderar, et al. 6,525,407 2/25/03 Drewery 6,339,253 1/15/02 Corisis 6,294,407 9/25/01 Jacobs 6,219,254 4/17/01 Akerling, et al. FOREIGN PATENT DOCUMENTS EXAM. REF. DOCUMENT NUMBER DATE COUNTRY CLASS SUB CLASS CLASS TRANSLATION YES/NO		1 1	DOCUMENT NUMBER	DATE	NAME	CLASS		FILING DATE IF APPROPRIATE
6,573,590 6/3/03 Radu, et al.			5,561,265	10/1/96	Livshits, et al.			
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6,597,575 7/22/03 Matayabes, et al. 6,320,257 11/20/01 Jayaraj, et al. 6,297,551 10/2/01 Dudderar, et al. 5,294,826 3/15/94 Marcantonio, et al. 6,525,407 2/25/03 Drewery 6,339,253 1/15/02 Corisis 6,294,407 9/25/01 Jacobs 6,219,254 4/17/01 Akerling, et al. FOREIGN PATENT DOCUMENTS EXAM. REF, DOCUMENT NUMBER DATE COUNTRY CLASS SUB CLASS VES/NO A1 03/041466 5/15/03 WO OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.) A2 Radu, et al., "Investigation of Internal Partitioning in Metallic Enclsosures for EMI Control," Sun Microsystems, Inc, et al., 6/97, pp. 171-176. A3 Article: "Identifying an EMI Source and Coupling Path in a Computer System with Sub-Module Testing"; Radu, et al.; Electromagnetic Compatibility Laboratory, Dept. of Electrical Engineering, University of Missouri-Rolla, Rolla, MO and Electromagnetic Compatibility Group, Sun Microsystems, Mountain View, CA; pgs. 165-170. A4 Article: "Intel® Pentium® 4 Processor in the 423-Pin Package EMI Guideline"; October 2000; ©Intel Corporation.			6,483,406	11/19/02	Sawa, et al.			
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Corporation.		A3	Radu, et al.; Electromagneti Missouri-Rolla, Rolla, MO	ic Compatibility L	aboratory, Dept. of Electrica	l Engineerir	ng, Universi	ty of
A5 Article: "Mechanical Enabling Efforts"; Fall 2000; Intel Developer Forum; ©Intel Corporation.		A4		4 Processor in the	e 423-Pin Package EMI Guid	eline"; Octo	ber 2000; ©	Olntel
		A5	Article: "Mechanical Enab	ling Efforts"; Fall	2000; Intel Developer Forur	n; ©Intel Co	orporation.	-

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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the patent owner.